

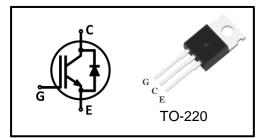
Features

- Easy parallel switching capability due to positive temperature coefficient in V_{CEsat}
- Low V_{CEsat}, fast switching
- High ruggedness, good thermal stability
- Very tight parameter distribution

Туре	Marking	Package Code
MPBP40N65EH	MP40N65EH	TO-220-3L

Applications

- UPS
- PFC
- **■** PTC Heater
- Climate Compressor



Maximum Rated Values 1

Parameter	Symbol	Value	Unit		
Collector-emitter voltage	V _{CE}	650	V		
DC collector current ²	•				
T _C =25°C		75			
T _C =100°C	7 ¹ c	40			
Pulsed collector current ³	I _{Cpuls}	160	_		
Diode forward current ²			A		
T _C =25°C	1	40			
T _C =100°C		20			
Diode pulsed current ³	I _{Fpuls}	120			
Gate-emitter voltage	V	±20	- v		
Transient Gate-emitter voltage (t _p ≤10us)	V _{GE}	±30			
Power dissipation					
T _C =25°C	D	250	W		
T _C =100°C	- P _{tot}	125			
Operating junction temperature	T _j		°C		
Storage temperature	T _{stg}	-55~150			

^{1:}Reference standard: JESD-022 2: limited by Tjmax 3: Tp limited by Tjmax ;



Thermal Characteristics

Parameter	Symbol	Max	Unit
IGBT thermal resistance, junction-case	R _{thJC}	0.6	
Diode thermal resistance, junction-case	R _{thJCD}	1.8	K/W
Thermal Resistance, junction-ambient	R_{thJA}	65	

Electrical Characteristics (at Tj=25°C, unless otherwise specified) Static Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter breakdown voltage	V _{(BR)CES}	V _{GE} =0V, I _C =0.25mA	650	-	-	
		V _{GE} =15V, I _C =40A T _j =25°C	1	1.50		
Collector-emitter saturation voltage	V _{CE(sat)}	T _j =125°C	ı	1.70	ı	
		T _j =150°C	ı	1.80	1	V
Diode forward voltage	V _F	V _{GE} =0V, I _F =20A T _j =25°C	1	1.45		
		T _j =125°C	-	1.30	-	
		T _j =150°C	ı	1.20	1	
G-E threshold voltage	$V_{GE(th)}$	$I_C=0.8$ mA, $V_{CE}=V_{GE}$		5.5		
C-E leakage current	I _{CES}	V _{CE} =650V, V _{GE} =0V T _j =25°C	1	1	0.1	mA
		T _j =150°C	-	-	1	
G-E leakage current	I _{GES}	V _{CE} =0V, V _{GE} =20V	-	-	250	nA
Transconductance	g _{FS}	V _{CE} =20V, I _C =40A	-	35	-	S

Dynamic Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Input capacitance	C _{iss}	\/ _25\/	-	2700	1	
Output capacitance	C _{oss}	V_{CE} =25V, V_{GE} =0V, f=1MHz	-	120	1	pF
Reverse transfer capacitance	C _{rss}		-	40	ı	
Gate charge	Q_{G}	V _{CC} =100V, I _C =40A, V _{GE} =15V	-	110	-	nC



IGBT Switching Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Turn-on delay time	t _{d(on)}		-	85	-	
Rise time	t _r	T _j =25°C,	-	55	-	
Turn-off delay time	t _{d(off)}	V _{CC} =400V,	-	190	1	ns
Fall time	t _f	I _C =40A, V _{GF} =0/15V,	-	40	-	
Turn-on energy	E _{on}	$R_{G}=10\Omega$,	-	0.81	-	mJ
Turn-off energy	E _{off}	Inductive load	-	0.85	-	
Total switching energy	E _{ts}		-	1.66	-	
Turn-on delay time	t _{d(on)}		-	85	-	
Rise time	t _r	$\begin{array}{c} T_{j}{=}150^{\circ}\text{C}, \\ V_{CC}{=}400\text{V}, \\ I_{C}{=}40\text{A}, \\ V_{GE}{=}0/15\text{V}, \\ R_{G}{=}10\Omega, \\ \text{Inductive load} \end{array}$	ı	70		
Turn-off delay time	t _{d(off)}		-	210	-	ns
Fall time	t _f		ı	60	1	
Turn-on energy	E _{on}		-	1.43	1	
Turn-off energy	E _{off}		-	1.12	-	mJ
Total switching energy	E _{ts}		-	2.55	-	

Diode Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Diode reverse recovery time	t _{rr}	T _i =25°C,	-	150	-	ns
Diode reverse recovery charge	Q _{rr}	T _j =25°C, V _R =400V, I _F =40A,	1	1.06	1	μC
Diode peak reverse recovery current	I _{rrm}	di _F /dt=640A/µs	1	15.4	1	Α
Diode reverse recovery time	t _{rr}	T _i =150°C,	1	240	1	Ns
Diode reverse recovery charge	Q _{rr}	T _j =150°C, V _R =400V, I _F =40A, di _F /dt=640A/μs	1	2.32	1	μC
Diode peak reverse recovery current	I _{rrm}		-	21.0	-	А



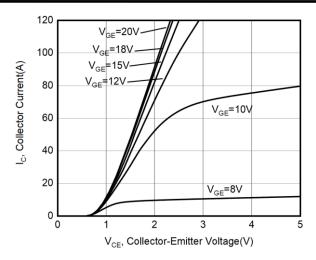


Figure 1. Typical output characteristic $(T_i = 25^{\circ}\text{C})$

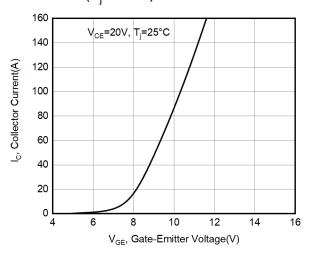


Figure 3. Typical transfer characteristic $(T_i = 25^{\circ}\text{C})$

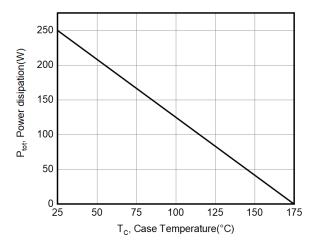


Figure 5. Power dissipation as a function of case temperature $(T_i \le 175^{\circ}C)$

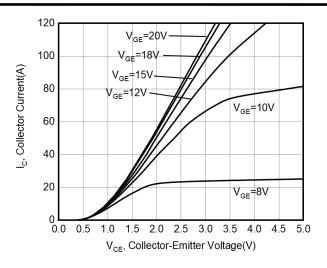


Figure 2. Typical output characteristic $(T_i = 150^{\circ}\text{C})$

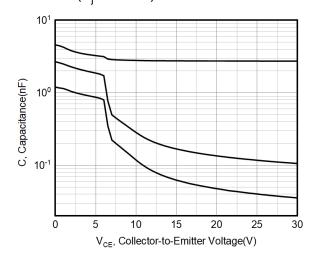


Figure 4. Capacitance characteristic $(V_{GF}=0V, f=1MHz)$

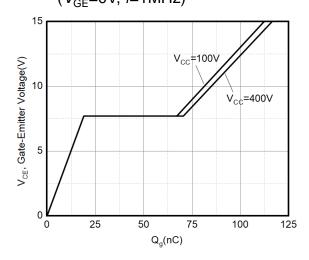


Figure 6. Typical gate charge ($I_C = 40A$)



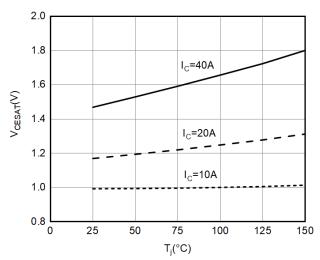


Figure 7. V_{CESAT} as a function of junction temperature (V_{GE} =15V)

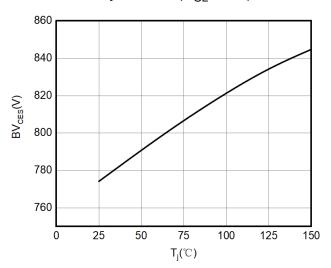


Figure 9. BV as a function of junction temperature (I_{CE} =250µA)

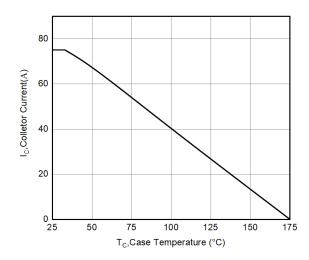


Figure 11. Collector current as a function of case temperature ($V_{GF} \ge 15 \text{V}$, $T_i \le 150 ^{\circ}\text{C}$)

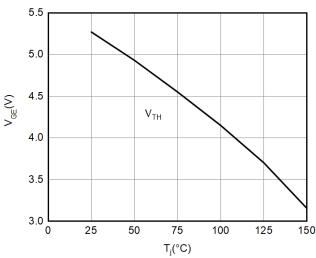


Figure 8. V_{TH} as a function of junction temperature (I_{CE} =250 μ A)

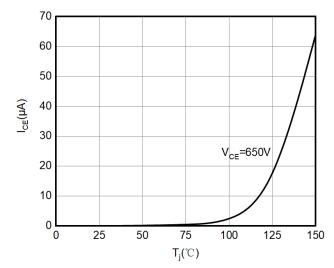


Figure 10. I_{CES} leakage current as a function of junction temperature

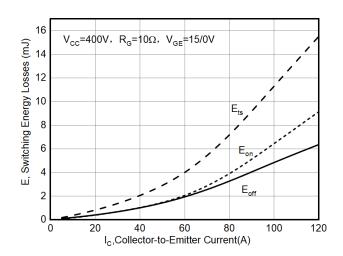


Figure 12. $E_{on,} E_{off}$ as a function of I_{C} $(T_{j}=25^{\circ}C)$



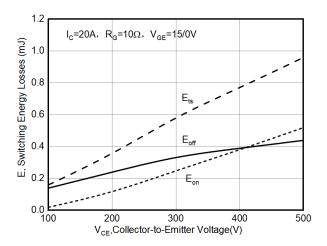


Figure 13. E_{on} , E_{off} as a function of V_{CE} $(T_i=25^{\circ}C)$

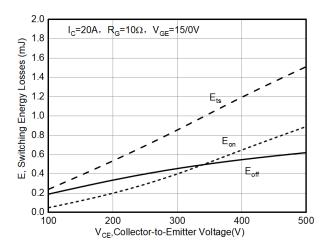


Figure 15. E_{on} , E_{off} as a function of V_{CE} (T_{j} =150°C)

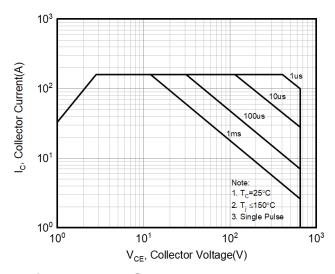


Figure 17. FBSOA

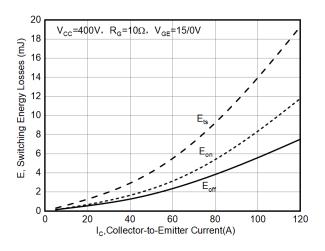


Figure 14. E_{on} , E_{off} as a function of I_{C} $(T_{i}=150^{\circ}C)$

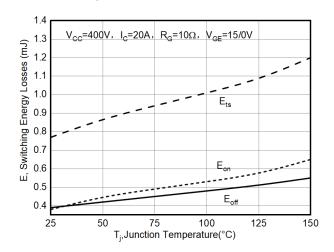
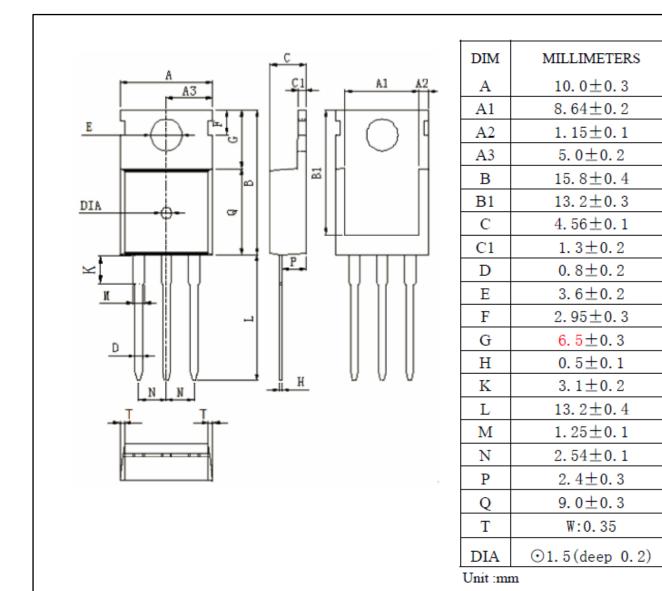


Figure 16. E_{on,} E_{off} as a function of junction temperature



TO-220-3L





Revision History:

Revision	Date	Subjects (major changes since last revision)
1.0	2023-02	Initial Version



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